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13 November 1963 Refer: SD-550

25X1A

| Subject: | Submission of TD 4006C - Changing Temperature Sensors to Newer Types on 4 "A" Follow-On Systems |
|------------|---|
| Enclosure: | (A) Cost Breakdown |
| | (B) Bill of Materials |

Dear Art:

Enclosures (A) and (B) are transmitted herewith for your review and evaluation.

FSDS is proceeding to order new temperature sensors for installation on the 4 "A" Follow-On Systems in compliance with Prime TWX 8352, dated 10/22/63. The Cost Estimate reflected in Enclosure (A) covers the cost of replacing the existing strip type temperature sensors with Micro Systems TE-3D-2000 button type sensors and the necessary T/M bridging circuitry.

Upon completion of your review, it is requested that a date be established to finalize this effort.

Thank you for your cooperation in this matter.

Very truly yours,

STATINTL

Encs.

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